VIII. We Claim:

A circuit board including:

a base:

: a conductive layer adjacent to the base;

a dielectric material adjacent to conductive layer;

; a tooth structure including a metal layer set in the dielectric

material to join the dielectric material to the metal layer; and

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wherein the metal layer forms a portion of circuitry in a circuit board having multiple layers of circuitry.

- 2. The electrical device of claim 1, wherein the layers have a peal strength greater than the peel strength of a single desmear process.
- The electrical device of claim 1, wherein the circuitry includes at least one micro via formed in the dielectric material.
- The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 20% of the teeth are obtuse shaped.
- The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 50% of the teeth are obtuse shaped.
- 6. The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 20% of the teeth are within the range of at least 1 tenth of a mil deep to 2 tenths of a mil deep.
- The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 50% of the teeth are at least 1 tenth of a mil deep to 2 tenths of a mil deep.
- The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 20% of the teeth are in the range of at least 1.5 tenths of a mil deep to 1.75 tenths of a mil deep.
- 9. The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 50% of the teeth are in the range of at least 1.5 tenths of a mil deep to 1.75 tenths of a mil deep.

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- 10. The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 5,000 teeth per linear inch can be found.
- 11. The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 10,000 teeth per linear inch can be found.
 - 12. The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 15,000 teeth per linear inch can be found.
 - 13. The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 25,000 teeth per square inch can be found.
 - 14. The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 100,000 teeth per square inch can be found.
 - 15. The electrical device of claim 1, wherein the tooth structure includes teeth and in a sample of the electrical device, at least 200,000 teeth per square inch can be found.
 - 16. The electrical device of claim 1, further including a second tooth structure that is not set in the dielectric material.
 - 17. The electrical device of claim 1, further including a second tooth structure a tooth structure including the conductive layer set in the dielectric material to join the conductive layer to the dielectric material; wherein,

the second tooth structure formed by an oxide replacement process; and wherein

the electrical circuitry includes a connection through a micro via.

- 18. The electrical device of claim 1, wherein the tooth structure is formed by a direct plate process.
- 19. The electrical device of claim 1, wherein the tooth structure is formed by a double desmear process.